

**Harvatek Surface Mount CHIP LEDs Data Sheet
B18W1IRP-A1C0001X4U1930**

Official Product	HT Part No. B18W1IRP-A1C0001X4U1930	Customer Part No.	Data Sheet No.	
Tentative Product	*****	*****	-	
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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

Item	Specification	Material	Quantity
Peak Wavelength λ_p	Typ: 850nm @100 mA/ $T_s = 25^\circ\text{C}$		
Radiant Intensity I_e	Typ: 23 mW/sr @100 mA/ $T_s = 25^\circ\text{C}$		
Forward Voltage V_F	1.4~2.0 V @100 mA/ $T_s = 25^\circ\text{C}$; Tolerance: $\pm 0.1\text{V}$		
Reverse Current I_R	$< 10 \mu\text{A}$ @ $V_R = 5\text{V}$		
Resin	Clean	Epoxy	
Carrier tape	EIA 481-1A specs	Conductive black tape	4000ea/reel
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of I_v , CIE and V_f . Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note :This is shipped test conditions

※Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

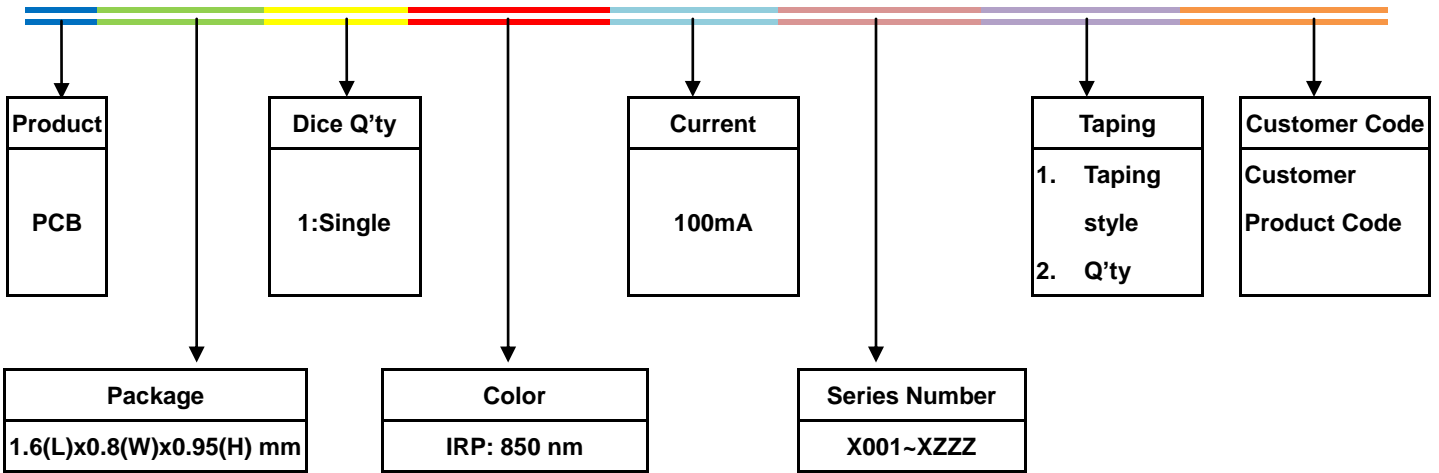
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Label Specifications



Harvatek P/N:

B 18W 1 IRP- A1C 0001 X4 U1930



Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	A	1	A	2	2	L	1	2
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecutive number		Special code		
Internal Tracing Code		2010-A		1:A	01~ZZ		000~ZZZ		
		2011-B		2:B					
		2012-C	1:Jan.	3:C					
		...	2:Feb.	...					
		2018-I/J	...	26:Z					
		2019-K	A:Oct.	27:7					
		...	B:Nov.	28:8					
2022-N	C:Dec.	29:9							
2023-P		30:3							
...		31:4							

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Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
I_F	Forward Current	100	mA	
I_{FP}	Peak Forward Current	1	A	1
V_R	Reverse Voltage	5	V	
T_{opr}	Operating Temperature	-40 ~ +85	°C	
T_{stg}	Storage Temperature	-40 ~ +100	°C	
T_{sol}	Soldering Temperature	260	°C	2
P_d	Total Power Dissipation	130	mW	

Notes:

- I_{FP} Conditions--Pulse Width $\leq 100\mu s$ and Duty $\leq 1\%$.
- Soldering time ≤ 5 seconds.

Electro-Optical Characteristics

Symbol	Parameters	Test conditions	Min	Typ	Max	Units	Notes
I_e	Radiant Intensity	$I_F=100mA$		23		mW/sr	3
λ_P	Peak Wavelength	$I_F=100mA$	-	850	-	nm	
$\Delta\lambda$	Spectral Bandwidth	$I_F=100mA$	-	50	-	nm	
V_F	Forward Voltage	$I_F=100mA$	1.4	-	2.0	V	4
I_R	Reverse Current	$V_R=5V$	-	-	10	μA	
$2\theta_{1/2}$	Angle of Half Intensity	$I_F=100mA$	-	80	-	deg	

Notes:

- Radiant Intensity (I_e) Bin:

Color	Bin Code	Spec. Range
IRP	PL	17.5~20 mw/sr
	PMQ	20.~30 mw/sr
	PRU	30~40 mw/sr

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Notes:

4. Forward Voltage (V_F) Bin:

Color	Bin Code	Spec. Range
IRP	D6	1.4-1.6 V
	E5	1.6-1.8 V
	E6	1.8-2.0 V

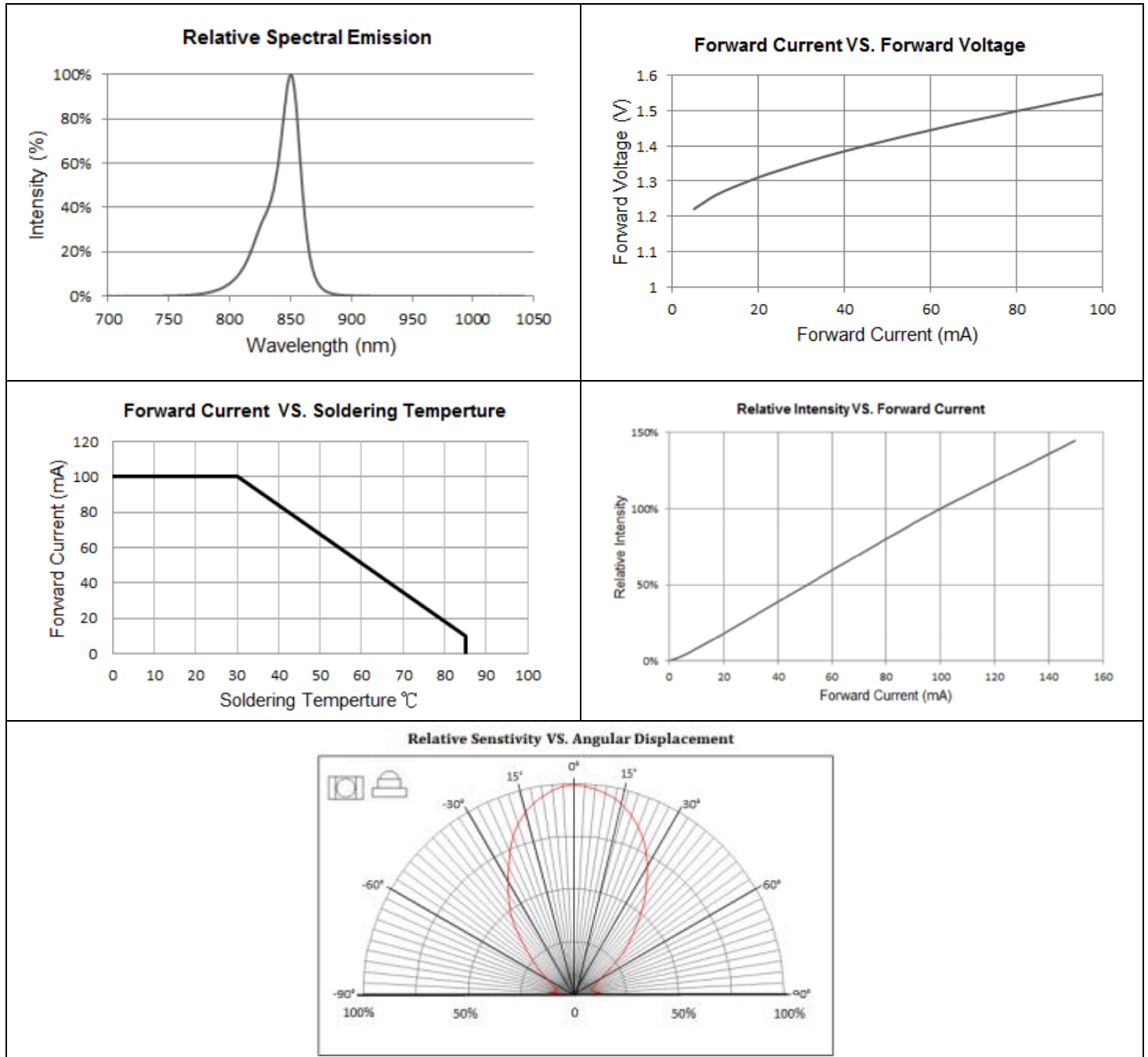
Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

(Unit: mm Tolerance: +/-0.1)

Outline Dim.	Soldering Pattern
<p>Soldering terminals may shift in the x, y direction.</p>	

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Characteristics of B18W1IRP



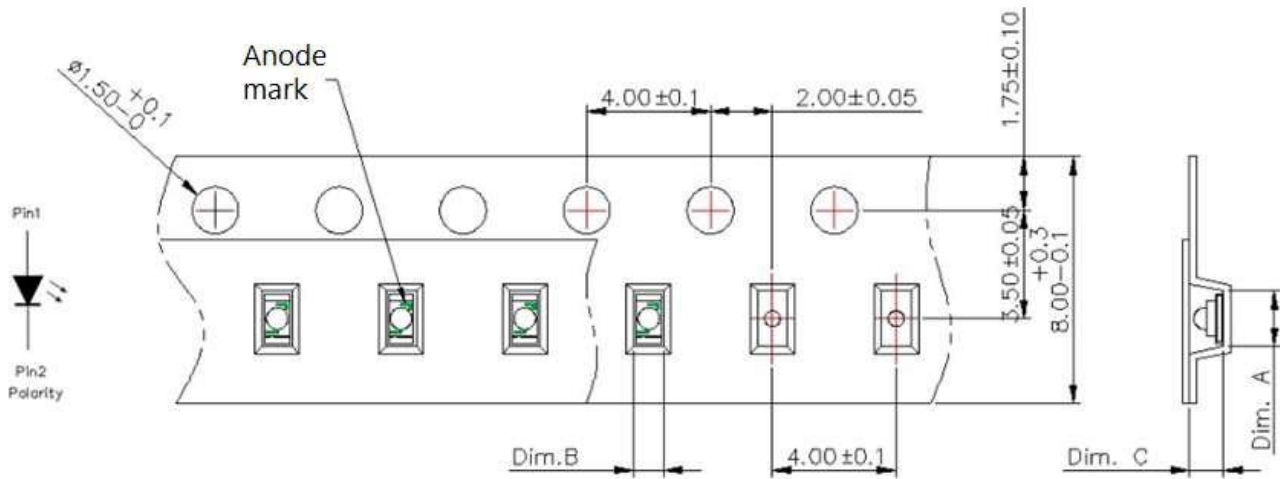
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Precaution for Use

1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
5. The appearance and specifications of the products may be modified for improvement without further notice.
6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

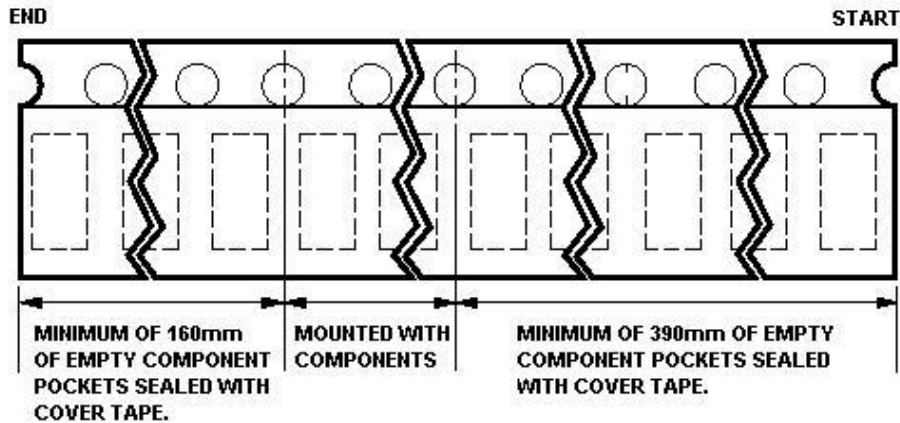
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Packaging Tape Dimension



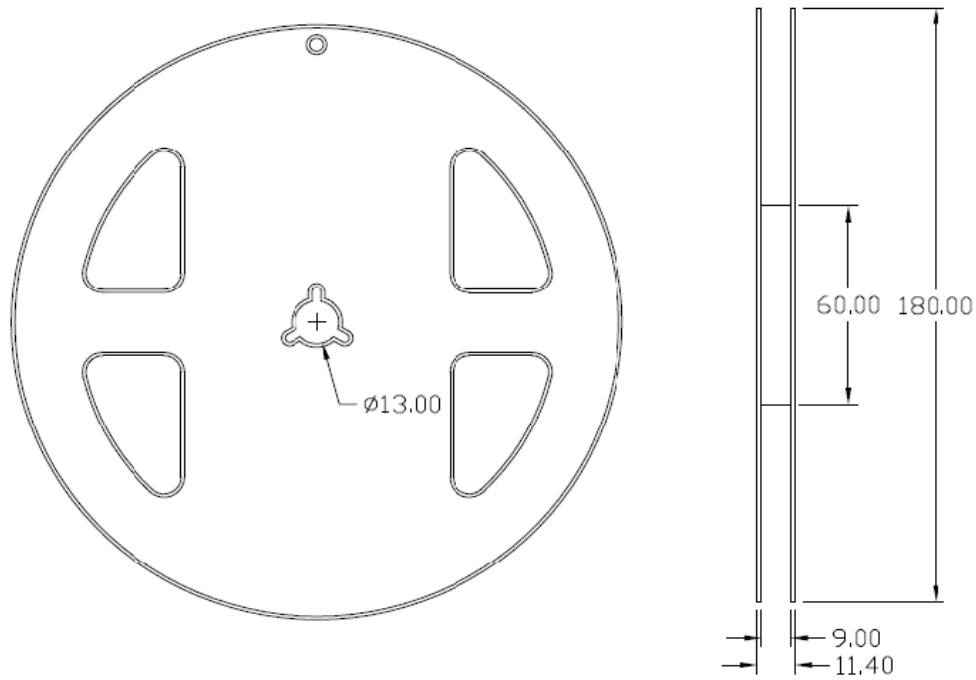
Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.85±0.05	0.88±0.05	0.95±0.05	4K

Unit: mm

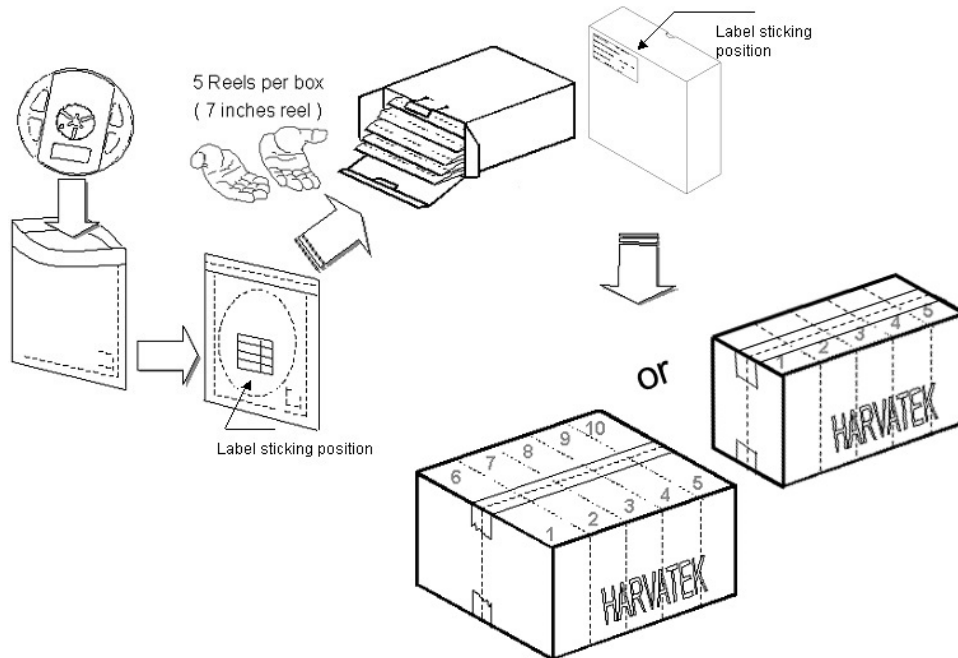


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Reel Dimension



Packing



5 or 10 boxes per carton is available depending on shipment quantity.

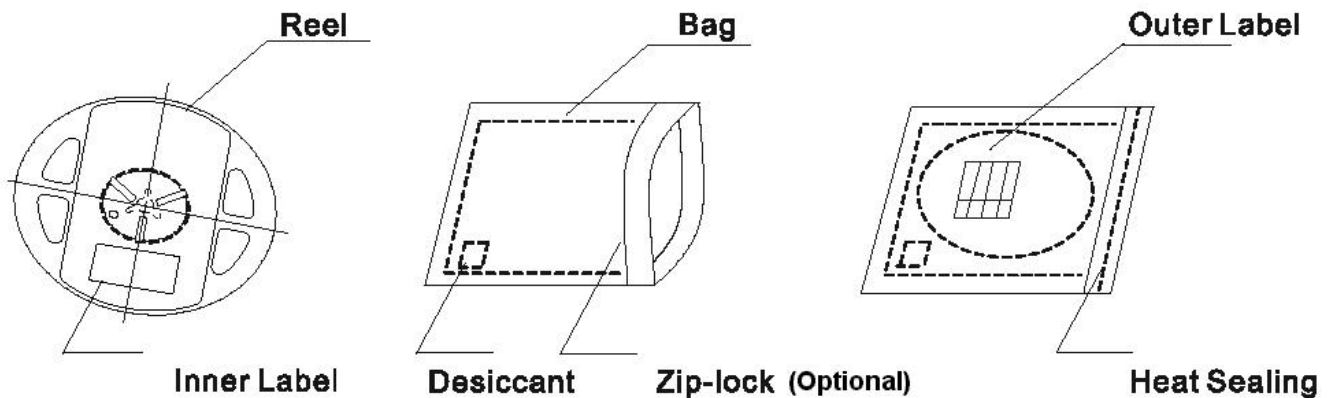
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Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 4 weeks.

The conditions are as followings:

1. $60\pm 3^{\circ}\text{C} \times (12\sim 24\text{hrs})$ and $<5\% \text{RH}$, taped reel type.
2. $100\pm 3^{\circ}\text{C} \times (45\text{min}\sim 1\text{hr})$, bulk type.
3. $130\pm 3^{\circ}\text{C} \times (15\text{min}\sim 30\text{min})$, bulk type.

Precautions

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

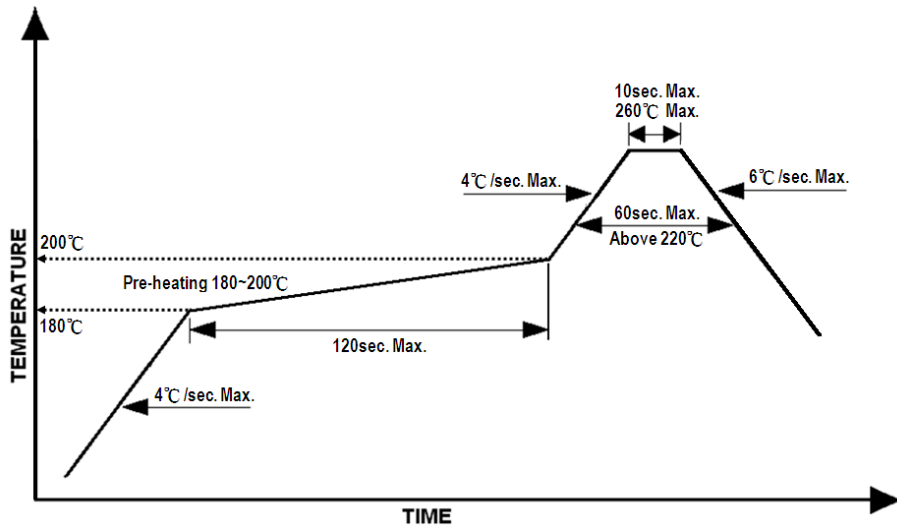
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Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 220°C ,60sec
2. Peak temp.:260°C Max.,10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never take next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measuring on the surface of the LED terminal) is following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100°C max, <3min

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